

LED430-06

- Blue LED
- 430 nm, 27 mW
- Chip: InGaN, 350 x 350 μm, 1 pc.
- 5 mm Clear Molding, Epoxy Resin
- Viewing Angle: 8°

Description





Rev. A1

LED430-06 contains one InGaN LED chip die with a typical peak wavelength of 430 nm and radiation power of 27 mW. It comes in Ø5 mm clear molding package with soldered lead frame (lead free) and lens molded with epoxy resin.

Maximum Ratings (T_{CASE}=25°C)

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Parameter	Symbol	Min.	Max.	Unit
Power Dissipation	PD		200	mW
Forward Current	IF		50	mA
Pulse Forward Current *1	I _{FP}		100	mA
Reverse Voltage	VF		5	V
Thermal Resistance	RTHJA		180	K/W
Junction Temperature	T_J		120	°C
Operating Temperature	T _{CASE}	- 20	+ 100	°C
Storage Temperature	T _{STG}	- 20	+ 100	°C
Lead Solder Temperature *2	T _{SLD}		+ 265	°C

*1 duty=1%, pulse width = 10 μ s

*2 must be completed within 5 seconds

Electro-Optical Characteristics (T_{CASE}=25°C)

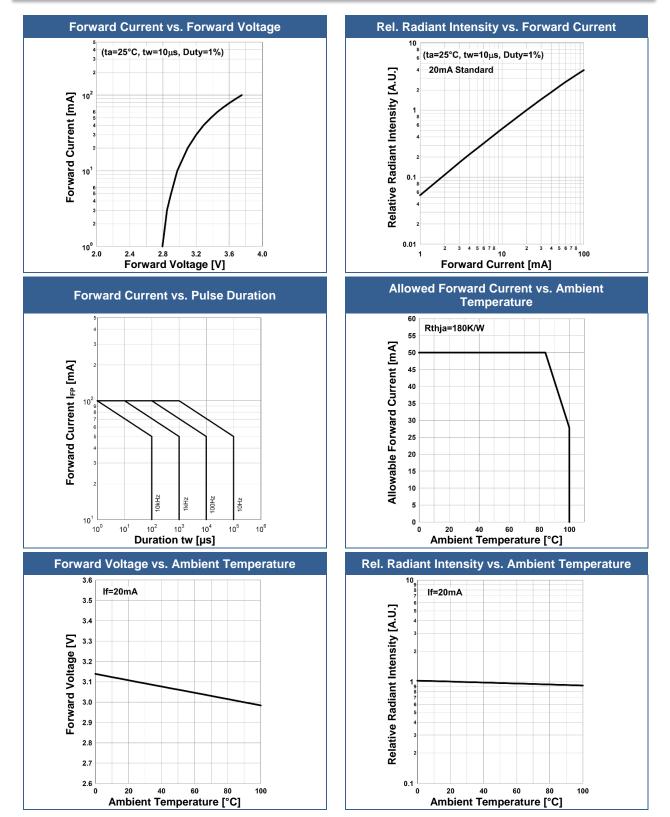
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	λ_P	I⊧=20mA	420		440	nm
Dominant Wavelength	λ_D	IF=20mA		437		Nm
Half Width	$\Delta \lambda$	I⊧=20mA		16		nm
	VF	I⊧=20mA		3.1	4.0	V
Forward Voltage	VFP	IFP=100mA		3.8		v
Radiated Power *1	Po	I⊧=20mA		27		mW
		IFP=100mA		100		
Dedient Intensity *2	1-	I⊧=20mA		310		mW/sr
Radiant Intensity *2	IE	IFP=100mA		1200		
Luminous Flux	${\cal P}_V$	I _F =20mA		380		mlm
Viewing Angle	20 1/2	I⊧=20mA		8		deg.
Rise Time	tr	I _F =20mA		20		ns
Fall Time	tr	I _F =20mA		20		ns

*1 measured by S3584-08

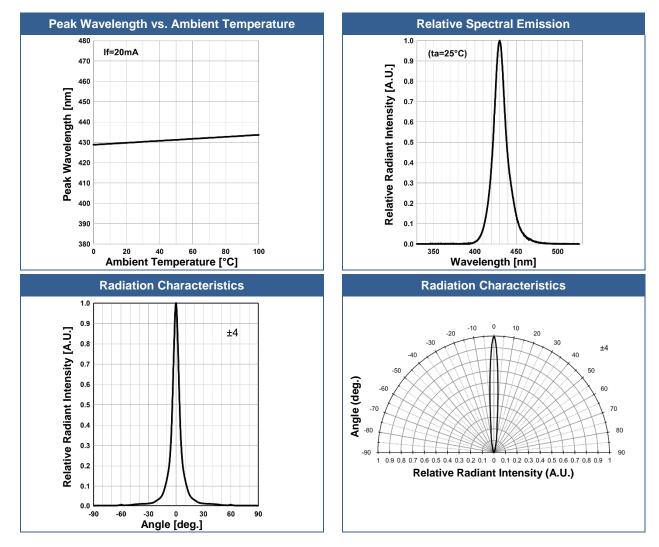
*2 measured by CIE127-2007 Condition B



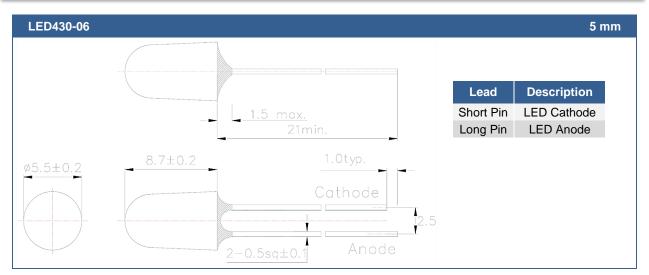
Typical Performance Curves







Outline Dimensions



All Dimensions in mm

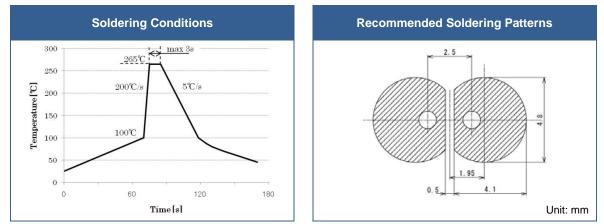


Precautions

Soldering:

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

Recommended soldering conditions:



Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

Cleaning:

Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS DO NOT USE ultrasonic cleaners

Static Electricity:

LEDs are sensitive to electrostatic discharge (ESD). Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

Radiation:

During operation these LEDs do emit light, which could be hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. Protective glasses if needed. It is further advised to attach a warning label on products/systems.

Operation:

Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.



Revisions History

Rel.	Rel. Date	Chapter	Modification	Page
A1	2020-05-26	-	Initial release	-

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